

## SN65HVD0x, SN75HVD0x High Output RS-485 Transceivers

### 1 Features

- Minimum differential output voltage of 2.5 V Into a 54-Ω load
- Open-circuit, short-circuit, and idle-bus failsafe receiver
- 1/8<sup>th</sup> Unit-load option available (Up to 256 nodes on the bus)
- Bus-pin ESD protection exceeds 16 kV HBM
- Driver output slew rate control options
- Electrically compatible with ANSI TIA/EIA-485-A standard
- Low-current standby mode: 1 μA typical
- Glitch-free power-up and power-down protection for hot-plugging applications
- Pin compatible with industry standard SN75176

### 2 Applications

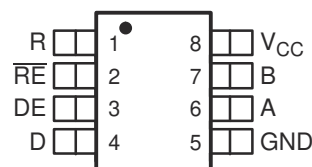
- Data transmission over long or lossy lines or electrically noisy environments
- Profibus line interface
- Industrial process control networks
- Point-of-sale (POS) networks
- Electric utility metering
- Building automation
- Digital motor control

### 3 Description

The SN65HVD05, SN75HVD05, SN65HVD06, SN75HVD06, SN65HVD07, and SN75HVD07 combine a 3-state differential line driver and differential line receiver. They are designed for balanced data transmission and interoperate with ANSI TIA/EIA-485-A and ISO 8482E standard-compliant devices. The driver is designed to provide a differential output voltage greater than that required by these standards for increased noise margin. The drivers and receivers have active-high and active-low enables respectively, which can be externally connected together to function as direction control.

The driver differential outputs and receiver differential inputs connect internally to form a differential input/output (I/O) bus port that is designed to offer minimum loading to the bus whenever the driver is disabled or not powered. These devices feature wide positive and negative common-mode voltage ranges, making them suitable for party-line applications.

D OR P PACKAGE  
(TOP VIEW)



LOGIC DIAGRAM  
(POSITIVE LOGIC)

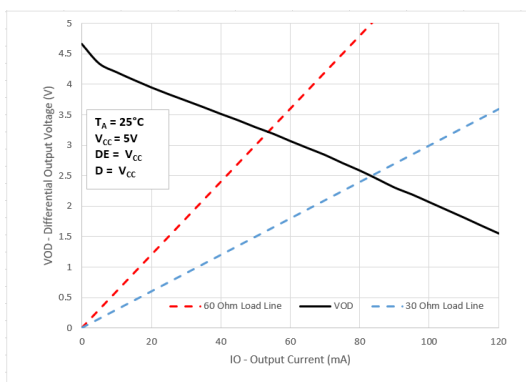
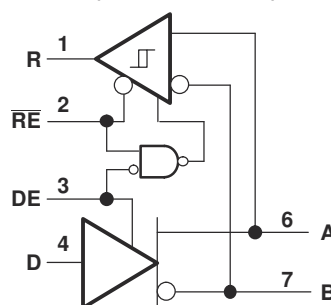


Figure 3-1. Differential Output Voltage vs Differential Output Current



## Table of Contents

|                                              |          |                                                              |           |
|----------------------------------------------|----------|--------------------------------------------------------------|-----------|
| <b>1 Features</b> .....                      | <b>1</b> | <b>Parameter Measurement Information</b> .....               | <b>12</b> |
| <b>2 Applications</b> .....                  | <b>1</b> | <b>6 Function Tables</b> .....                               | <b>16</b> |
| <b>3 Description</b> .....                   | <b>1</b> | 6.1 Receiver Failsafe.....                                   | 16        |
| <b>4 Revision History</b> .....              | <b>2</b> | <b>7 Equivalent Input and Output Schematic Diagrams</b> .... | <b>17</b> |
| <b>5 Specifications</b> .....                | <b>3</b> | <b>8 Application and Implementation</b> .....                | <b>18</b> |
| 5.1 Absolute Maximum Ratings.....            | 3        | Typical Application.....                                     | 18        |
| 5.2 Recommended Operating Conditions.....    | 3        | <b>9 Device and Documentation Support</b> .....              | <b>19</b> |
| 5.3 Thermal Information.....                 | 4        | 9.1 Receiving Notification of Documentation Updates....      | 19        |
| 5.4 Package Dissipation Ratings.....         | 4        | 9.2 Support Resources.....                                   | 19        |
| 5.5 Driver Electrical Characteristics.....   | 5        | 9.3 Trademarks.....                                          | 19        |
| 5.6 Driver Switching Characteristics.....    | 6        | 9.4 Electrostatic Discharge Caution.....                     | 19        |
| 5.7 Receiver Electrical Characteristics..... | 7        | 9.5 Glossary.....                                            | 19        |
| 5.8 Receiver Switching Characteristics.....  | 8        | <b>10 Mechanical, Packaging, and Orderable</b>               |           |
| 5.9 Typical Characteristics.....             | 9        | <b>Information</b> .....                                     | <b>19</b> |

## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

|                                                                         |             |
|-------------------------------------------------------------------------|-------------|
| <b>Changes from Revision E (August 2009) to Revision F (March 2023)</b> | <b>Page</b> |
| • Deleted the <i>Ordering Information</i> table.....                    | 1           |
| • Added the <i>Thermal Information</i> table.....                       | 4           |
| • Changed the <i>Typical Characteristics</i> .....                      | 9           |
| <b>Changes from Revision D (July 2006) to Revision E (August 2009)</b>  | <b>Page</b> |
| • Added IDLE Bus to the Receivers Function Table.....                   | 16          |
| • Added the Receiver Failsafe paragraph.....                            | 16          |

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range unless otherwise noted<sup>(1) (2)</sup>

|                                                                                                        |                                     |               | <b>SN65HVD05, SN65HVD06, SN65HVD07</b><br><b>SN75HVD05, SN75HVD06, SN75HVD07</b> |
|--------------------------------------------------------------------------------------------------------|-------------------------------------|---------------|----------------------------------------------------------------------------------|
| Supply voltage range, $V_{CC}$                                                                         |                                     |               | –0.3 V to 6 V                                                                    |
| Voltage range at A or B                                                                                |                                     |               | –9 V to 14 V                                                                     |
| Input voltage range at D, DE, R or $\overline{RE}$                                                     |                                     |               | –0.5 V to $V_{CC} + 0.5$ V                                                       |
| Voltage input range, transient pulse, A and B, through 100 $\Omega$ (see <a href="#">Figure 6-11</a> ) |                                     |               | –50 V to 50 V                                                                    |
| Receiver output current, $I_O$                                                                         |                                     |               | –11 mA to 11mA                                                                   |
| Electrostatic discharge                                                                                | Human body model <sup>(3)</sup>     | A, B, and GND | 16 kV                                                                            |
|                                                                                                        |                                     | All pins      | 4 kV                                                                             |
|                                                                                                        | Charged-device model <sup>(4)</sup> | All pins      | 1 kV                                                                             |
| Continuous total power dissipation                                                                     |                                     |               | See Dissipation Rating Table                                                     |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, except differential I/O bus voltages, are with respect to network ground terminal.
- (3) Tested in accordance with JEDEC Standard 22, Test Method A114-A.
- (4) Tested in accordance with JEDEC Standard 22, Test Method C101.

### 5.2 Recommended Operating Conditions

|                                                                           |                        | MIN               | NOM | MAX | UNIT |
|---------------------------------------------------------------------------|------------------------|-------------------|-----|-----|------|
| Supply voltage, $V_{CC}$                                                  |                        | 4.5               |     | 5.5 | V    |
| Voltage at any bus terminal (separately or common mode) $V_I$ or $V_{IC}$ |                        | −7 <sup>(1)</sup> |     | 12  | V    |
| High-level input voltage, $V_{IH}$                                        | D, DE, $\overline{RE}$ | 2                 |     |     | V    |
| Low-level input voltage, $V_{IL}$                                         | D, DE, $\overline{RE}$ |                   |     | 0.8 | V    |
| Differential input voltage, $V_{ID}$ (see <a href="#">Figure 6-7</a> )    |                        | −12               |     | 12  | V    |
| High-level output current, $I_{OH}$                                       | Driver                 | −100              |     |     | mA   |
|                                                                           | Receiver               | −8                |     |     |      |
| Low-level output current, $I_{OL}$                                        | Driver                 |                   |     | 100 | mA   |
|                                                                           | Receiver               |                   |     | 8   |      |
| Operating free-air temperature, $T_A$                                     | SN65HVD05              | −40               |     | 85  | °C   |
|                                                                           | SN65HVD06              |                   |     |     |      |
|                                                                           | SN65HVD07              |                   |     |     |      |
|                                                                           | SN75HVD05              | 0                 |     | 70  | °C   |
|                                                                           | SN75HVD06              |                   |     |     |      |
|                                                                           | SN75HVD07              |                   |     |     |      |

- (1) The algebraic convention, in which the least positive (most negative) limit is designated as minimum is used in this data sheet.

## 5.3 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | D (SOIC)<br>SN65<br>Variation | D (SOIC)<br>SN75<br>Variation | P (PDIP) | UNIT |
|-------------------------------|----------------------------------------------|-------------------------------|-------------------------------|----------|------|
|                               |                                              | 8 PINS                        | 8 PINS                        | 8 PINS   |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 116.7                         | 175.4                         | 125      | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 56.3                          | 53.6                          | 34.9     | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 63.4                          | 45.1                          | 23.7     | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 8.8                           | 10.1                          | 12.1     | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 62.6                          | 44.4                          | 23.6     | °C/W |

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

## 5.4 Package Dissipation Ratings

(See [Figure 5-1](#) and [Figure 5-2](#))

| PACKAGE          | T <sub>A</sub> ≤ 25°C<br>POWER RATING | DERATING FACTOR <sup>(1)</sup><br>ABOVE T <sub>A</sub> = 25°C | T <sub>A</sub> = 70°C<br>POWER RATING | T <sub>A</sub> = 85°C<br>POWER RATING |
|------------------|---------------------------------------|---------------------------------------------------------------|---------------------------------------|---------------------------------------|
| D <sup>(2)</sup> | 710 mW                                | 5.7 mW/°C                                                     | 455 mW                                | 369 mW                                |
| D <sup>(3)</sup> | 1282 mW                               | 10.3 mW/°C                                                    | 821 mW                                | 667 mW                                |
| P                | 1000 mW                               | 8.0 m W/°C                                                    | 640 mW                                | 520 mW                                |

- (1) This is the inverse of the junction-to-ambient thermal resistance when board-mounted and with no air flow.  
 (2) Tested in accordance with the Low-K thermal metric definitions of EIA/JESD51-3  
 (3) Tested in accordance with the High-K thermal metric definitions of EIA/JESD51-7

## 5.5 Driver Electrical Characteristics

over operating free-air temperature range unless otherwise noted

| PARAMETER            |                                                    |                                                                       | TEST CONDITIONS                                                  |   | MIN  | TYP <sup>(1)</sup> | MAX             | UNIT |
|----------------------|----------------------------------------------------|-----------------------------------------------------------------------|------------------------------------------------------------------|---|------|--------------------|-----------------|------|
| V <sub>IK</sub>      | Input clamp voltage                                |                                                                       | I <sub>I</sub> = −18 mA                                          |   | −1.5 |                    |                 | V    |
| V <sub>OD</sub>      | Differential output voltage                        |                                                                       | No Load                                                          |   |      |                    | V <sub>CC</sub> | V    |
|                      |                                                    |                                                                       | R <sub>L</sub> = 54 Ω, See <a href="#">Figure 6-4</a>            |   | 2.5  |                    |                 |      |
|                      |                                                    |                                                                       | V <sub>test</sub> = −7 V to 12 V, See <a href="#">Figure 6-2</a> |   | 2.2  |                    |                 |      |
| Δ V <sub>OD</sub>    | Change in magnitude of differential output voltage |                                                                       | See <a href="#">Figure 6-4</a> and <a href="#">Figure 6-2</a>    |   | −0.2 |                    | 0.2             | V    |
| V <sub>OC(SS)</sub>  | Steady-state common-mode output voltage            |                                                                       | See <a href="#">Figure 6-3</a>                                   |   | 2.2  |                    | 3.3             | V    |
| ΔV <sub>OC(SS)</sub> | Change in steady-state common-mode output voltage  |                                                                       |                                                                  |   | −0.1 |                    | 0.1             | V    |
| V <sub>OC(PP)</sub>  | Peak-to-peak common-mode output voltage            | HVD05                                                                 | See <a href="#">Figure 6-3</a>                                   |   | 600  |                    |                 | mV   |
|                      |                                                    | HVD06                                                                 |                                                                  |   | 500  |                    |                 |      |
|                      |                                                    | HVD07                                                                 |                                                                  |   | 900  |                    |                 |      |
| I <sub>OZ</sub>      | High-impedance output current                      |                                                                       | See receiver input currents                                      |   |      |                    |                 |      |
| I <sub>I</sub>       | Input current                                      | D                                                                     |                                                                  |   | −100 |                    | 0               | μA   |
|                      |                                                    | DE                                                                    |                                                                  |   | 0    |                    | 100             |      |
| I <sub>OS</sub>      | Short-circuit output current                       |                                                                       | −7 V ≤ V <sub>O</sub> ≤ 12 V                                     |   | −250 |                    | 250             | mA   |
| C <sub>(diff)</sub>  | Differential output capacitance                    |                                                                       | V <sub>ID</sub> = 0.4 sin (4E6πt) + 0.5 V, DE at 0 V             |   | 16   |                    |                 | pF   |
| I <sub>CC</sub>      | Supply current                                     | RE at V <sub>CC</sub> ,<br>D and DE at V <sub>CC</sub> ,<br>No load   | Receiver disabled<br>and driver enabled                          | 9 |      | 15                 | mA              |      |
|                      |                                                    | RE at V <sub>CC</sub> ,<br>D at V <sub>CC</sub> DE at 0 V,<br>No load | Receiver disabled<br>and driver disabled<br>(standby)            | 1 |      | 5                  | μA              |      |
|                      |                                                    | RE at 0 V,<br>D and DE at V <sub>CC</sub> ,<br>No load                | Receiver enabled<br>and driver enabled                           | 9 |      | 15                 | mA              |      |

(1) All typical values are at 25°C and with a 5-V supply.

## 5.6 Driver Switching Characteristics

over operating free-air temperature range unless otherwise noted

| PARAMETER          |                                                             | TEST CONDITIONS                                               | MIN | TYP <sup>(1)</sup> | MAX | UNIT    |
|--------------------|-------------------------------------------------------------|---------------------------------------------------------------|-----|--------------------|-----|---------|
| $t_{PLH}$          | Propagation delay time, low-to-high-level output            | HVD05                                                         |     | 6.5                | 11  | ns      |
|                    |                                                             | HVD06                                                         |     | 27                 | 40  |         |
|                    |                                                             | HVD07                                                         |     | 250                | 400 |         |
| $t_{PHL}$          | Propagation delay time, high-to-low-level output            | HVD05                                                         |     | 6.5                | 11  | ns      |
|                    |                                                             | HVD06                                                         |     | 27                 | 40  |         |
|                    |                                                             | HVD07                                                         |     | 250                | 400 |         |
| $t_r$              | Differential output signal rise time                        | HVD05                                                         | 2.7 | 3.6                | 6   | ns      |
|                    |                                                             | HVD06                                                         | 18  | 28                 | 55  |         |
|                    |                                                             | HVD07                                                         | 150 | 300                | 450 |         |
| $t_f$              | Differential output signal fall time                        | HVD05                                                         | 2.7 | 3.6                | 6   | ns      |
|                    |                                                             | HVD06                                                         | 18  | 28                 | 55  |         |
|                    |                                                             | HVD07                                                         | 150 | 300                | 450 |         |
| $t_{sk(p)}$        | Pulse skew ( $ t_{PHL} - t_{PLH} $ )                        | HVD05                                                         |     | 2                  |     | ns      |
|                    |                                                             | HVD06                                                         |     | 2.5                |     |         |
|                    |                                                             | HVD07                                                         |     | 10                 |     |         |
| $t_{sk(pp)}^{(2)}$ | Part-to-part skew                                           | HVD05                                                         |     | 3.5                |     | ns      |
|                    |                                                             | HVD06                                                         |     | 14                 |     |         |
|                    |                                                             | HVD07                                                         |     | 100                |     |         |
| $t_{PZH1}$         | Propagation delay time, high-impedance-to-high-level output | HVD05                                                         |     | 25                 |     | ns      |
|                    |                                                             | HVD06                                                         |     | 45                 |     |         |
|                    |                                                             | HVD07                                                         |     | 250                |     |         |
| $t_{PHZ}$          | Propagation delay time, high-level-to-high-impedance output | HVD05                                                         |     | 25                 |     | ns      |
|                    |                                                             | HVD06                                                         |     | 60                 |     |         |
|                    |                                                             | HVD07                                                         |     | 250                |     |         |
| $t_{PZL1}$         | Propagation delay time, high-impedance-to-low-level output  | HVD05                                                         |     | 15                 |     | ns      |
|                    |                                                             | HVD06                                                         |     | 45                 |     |         |
|                    |                                                             | HVD07                                                         |     | 200                |     |         |
| $t_{PLZ}$          | Propagation delay time, low-level-to-high-impedance output  | HVD05                                                         |     | 14                 |     | ns      |
|                    |                                                             | HVD06                                                         |     | 90                 |     |         |
|                    |                                                             | HVD07                                                         |     | 550                |     |         |
| $t_{PZH2}$         | Propagation delay time, standby-to-high-level output        | $R_L = 110\Omega$ , $\overline{RE}$ at 3 V,<br>See Figure 6-5 |     |                    | 6   | $\mu s$ |
| $t_{PZL2}$         | Propagation delay time, standby-to-low-level output         | $R_L = 110\Omega$ , $\overline{RE}$ at 3 V,<br>See Figure 6-6 |     |                    | 6   | $\mu s$ |

(1) All typical values are at 25°C and with a 5-V supply.

(2)  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.

## 5.7 Receiver Electrical Characteristics

over operating free-air temperature range unless otherwise noted

| PARAMETER           |                                                           | TEST CONDITIONS                                                   |                                                 |                                          | MIN                   | TYP <sup>(1)</sup> | MAX   | UNIT |    |
|---------------------|-----------------------------------------------------------|-------------------------------------------------------------------|-------------------------------------------------|------------------------------------------|-----------------------|--------------------|-------|------|----|
| V <sub>IT+</sub>    | Positive-going input threshold voltage                    | I <sub>O</sub> = −8 mA                                            |                                                 |                                          |                       |                    | −0.01 | V    |    |
| V <sub>IT-</sub>    | Negative-going input threshold voltage                    | I <sub>O</sub> = 8 mA                                             |                                                 |                                          |                       |                    | −0.2  |      |    |
| V <sub>hys</sub>    | Hysteresis voltage (V <sub>IT+</sub> - V <sub>IT-</sub> ) |                                                                   |                                                 |                                          |                       |                    | 35    | mV   |    |
| V <sub>IK</sub>     | Enable-input clamp voltage                                | I <sub>I</sub> = −18 mA                                           |                                                 |                                          |                       |                    | −1.5  | V    |    |
| V <sub>OH</sub>     | High-level output voltage                                 | V <sub>ID</sub> = 200 mV,                                         | I <sub>OH</sub> = −8 mA,                        | See Figure 6-7                           |                       |                    | 4     | V    |    |
| V <sub>OL</sub>     | Low-level output voltage                                  | V <sub>ID</sub> = -200 mV,                                        | I <sub>OL</sub> = 8 mA,                         | See Figure 6-7                           |                       |                    | 0.4   | V    |    |
| I <sub>OZ</sub>     | High-impedance-state output current                       | V <sub>O</sub> = 0 or V <sub>CC</sub>                             | RE at V <sub>CC</sub>                           |                                          |                       |                    | −1    | 1    | μA |
| I <sub>I</sub>      | Bus input current                                         | HVD05                                                             | Other inputat 0 V                               | V <sub>A</sub> or V <sub>B</sub> = 12 V  |                       |                    | 0.23  | 0.5  | mA |
|                     |                                                           |                                                                   |                                                 | V <sub>A</sub> or V <sub>B</sub> = 12 V, | V <sub>CC</sub> = 0 V |                    | 0.3   | 0.5  |    |
|                     |                                                           |                                                                   |                                                 | V <sub>A</sub> or V <sub>B</sub> = −7 V  |                       |                    | −0.4  | 0.13 |    |
|                     |                                                           |                                                                   |                                                 | V <sub>A</sub> or V <sub>B</sub> = −7 V, | V <sub>CC</sub> = 0 V |                    | −0.4  | 0.15 |    |
|                     |                                                           | HVD06<br>HVD07                                                    | Other inputat 0 V                               | V <sub>A</sub> or V <sub>B</sub> = 12 V  |                       |                    | 0.06  | 0.1  | mA |
|                     |                                                           |                                                                   |                                                 | V <sub>A</sub> or V <sub>B</sub> = 12 V, | V <sub>CC</sub> = 0 V |                    | 0.08  | 0.13 |    |
|                     |                                                           |                                                                   |                                                 | V <sub>A</sub> or V <sub>B</sub> = −7 V  |                       |                    | −0.1  | 0.05 |    |
|                     |                                                           |                                                                   |                                                 | V <sub>A</sub> or V <sub>B</sub> = −7 V, | V <sub>CC</sub> = 0 V |                    | −0.05 | 0.03 |    |
| I <sub>IH</sub>     | High-level input current, RE                              | V <sub>IH</sub> = 2 V                                             |                                                 |                                          |                       |                    | −60   | 26.4 | μA |
| I <sub>IL</sub>     | Low-level input current, RE                               | V <sub>IL</sub> = 0.8 V                                           |                                                 |                                          |                       |                    | −60   | 27.4 | μA |
| C <sub>(diff)</sub> | Differential input capacitance                            | V <sub>I</sub> = 0.4 sin (4E6πrt) + 0.5 V, DE at 0 V              |                                                 |                                          |                       |                    | 16    |      | pF |
| I <sub>CC</sub>     | Supply current                                            | RE at 0 V, D and DE at 0 V, No load                               | Receiver enabled and driver disabled            |                                          |                       |                    | 5     | 10   | mA |
|                     |                                                           | RE at V <sub>CC</sub> , DE at 0 V, D at V <sub>CC</sub> , No load | Receiver disabled and driver disabled (standby) |                                          |                       |                    | 1     | 5    | μA |
|                     |                                                           | RE at 0 V, D and DE at V <sub>CC</sub> , No load                  | Receiver enabled and driver enabled             |                                          |                       |                    | 9     | 15   | mA |

(1) All typical values are at 25°C and with a 5-V supply.

## 5.8 Receiver Switching Characteristics

over operating free-air temperature range unless otherwise noted

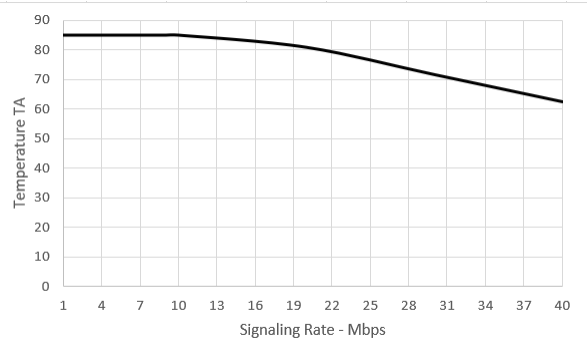
| PARAMETER                   |                                                         |       | TEST CONDITIONS                                                                                        | MIN | TYP <sup>(1)</sup> | MAX | UNIT          |
|-----------------------------|---------------------------------------------------------|-------|--------------------------------------------------------------------------------------------------------|-----|--------------------|-----|---------------|
| $t_{PLH}$                   | Propagation delay time, low-to-high-level output 1/2 UL | HVD05 | $V_{ID} = -1.5\text{ V to }1.5\text{ V}$ ,<br>$C_L = 15\text{ pF}$ ,<br>See <a href="#">Figure 6-8</a> |     | 14.6               | 25  | ns            |
| $t_{PHL}$                   | Propagation delay time, high-to-low-level output 1/2 UL | HVD05 |                                                                                                        |     | 14.6               | 25  | ns            |
| $t_{PLH}$                   | Propagation delay time, low-to-high-level output 1/8 UL | HVD06 |                                                                                                        |     | 55                 | 70  | ns            |
|                             |                                                         | HVD07 |                                                                                                        |     | 55                 | 70  |               |
| $t_{PHL}$                   | Propagation delay time, high-to-low-level output 1/8 UL | HVD06 |                                                                                                        |     | 55                 | 70  | ns            |
|                             |                                                         | HVD07 |                                                                                                        |     | 55                 | 70  |               |
| $t_{sk(p)}$                 | Pulse skew ( $ t_{PHL} - t_{PLH} $ )                    | HVD05 |                                                                                                        |     |                    | 2   | ns            |
|                             |                                                         | HVD06 |                                                                                                        |     |                    | 4.5 |               |
|                             |                                                         | HVD07 |                                                                                                        |     |                    | 4.5 |               |
| $t_{sk(pp)}$ <sup>(2)</sup> | Part-to-part skew                                       | HVD05 |                                                                                                        |     |                    | 6.5 | ns            |
|                             |                                                         | HVD06 |                                                                                                        |     |                    | 14  |               |
|                             |                                                         | HVD07 |                                                                                                        |     |                    | 14  |               |
| $t_r$                       | Output signal rise time                                 |       | $C_L = 15\text{ pF}$ ,<br>See <a href="#">Figure 6-8</a>                                               |     | 2                  | 3   | ns            |
| $t_f$                       | Output signal fall time                                 |       |                                                                                                        |     | 2                  | 3   |               |
| $t_{PZH1}$                  | Output enable time to high level                        |       | $C_L = 15\text{ pF}$ ,<br>DE at 3 V,<br>See <a href="#">Figure 6-9</a>                                 |     |                    | 10  | ns            |
| $t_{PZL1}$                  | Output enable time to low level                         |       |                                                                                                        |     |                    | 10  |               |
| $t_{PHZ}$                   | Output disable time from high level                     |       |                                                                                                        |     |                    | 15  |               |
| $t_{PLZ}$                   | Output disable time from low level                      |       |                                                                                                        |     |                    | 15  |               |
| $t_{PZH2}$                  | Propagation delay time, standby-to-high-level output    |       | $C_L = 15\text{ pF}$ , DE at 0,<br>See <a href="#">Figure 6-10</a>                                     |     |                    | 6   | $\mu\text{s}$ |
| $t_{PZL2}$                  | Propagation delay time, standby-to-low-level output     |       |                                                                                                        |     |                    | 6   |               |

(1) All typical values are at 25°C and with a 5-V supply.

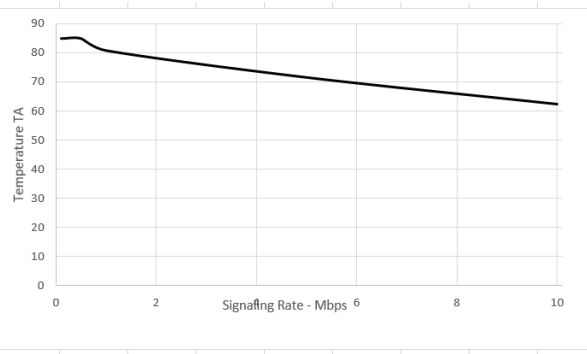
(2)  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.



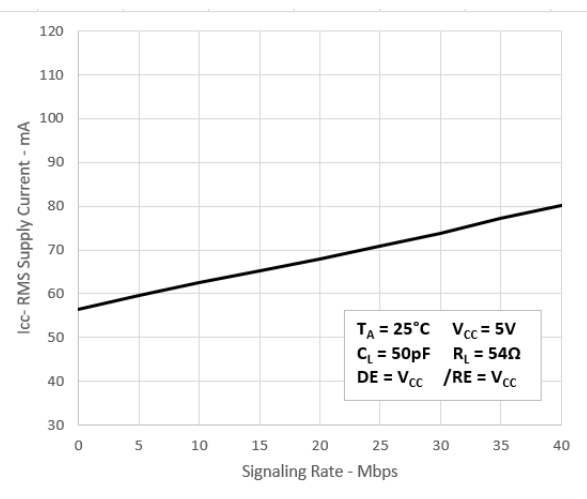
## 5.9 Typical Characteristics



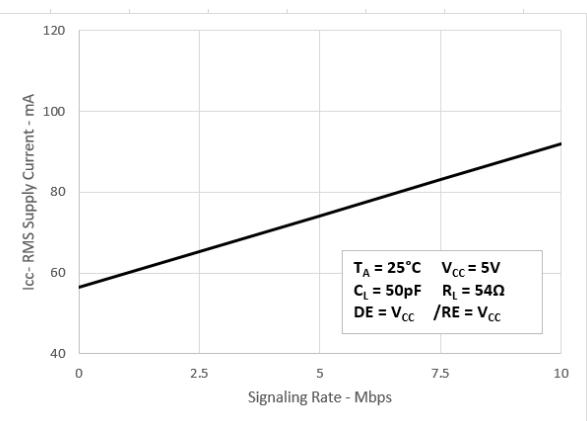
**Figure 5-1. HVD05 Maximum Recommended Still-Air Operating Temperature vs Signaling Rate (D-Package)**



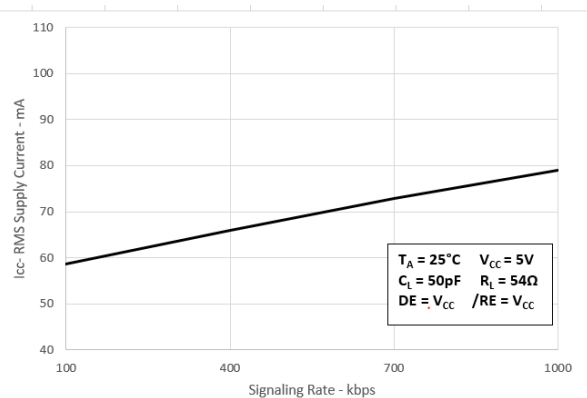
**Figure 5-2. HVD06 Maximum Recommended Still-Air Operating Temperature vs Signaling Rate (D-Package)**



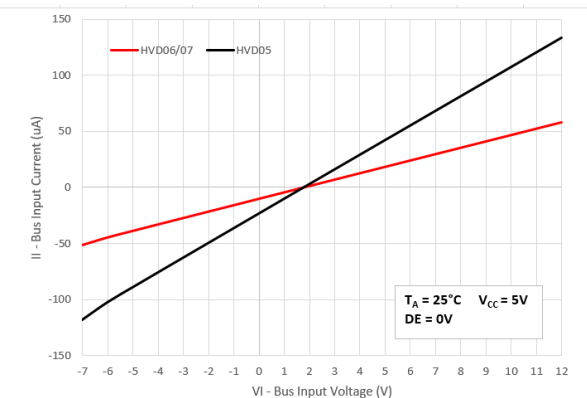
**Figure 5-3. HVD05 RMS Supply Current vs Signaling Rate**



**Figure 5-4. HVD06 RMS Supply Current vs Signaling Rate**

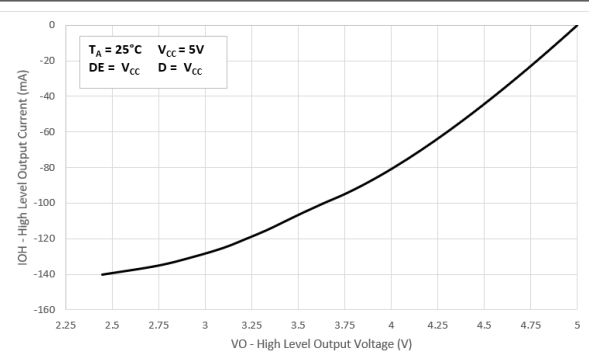


**Figure 5-5. HVD07 RMS Supply Current vs Signaling Rate**

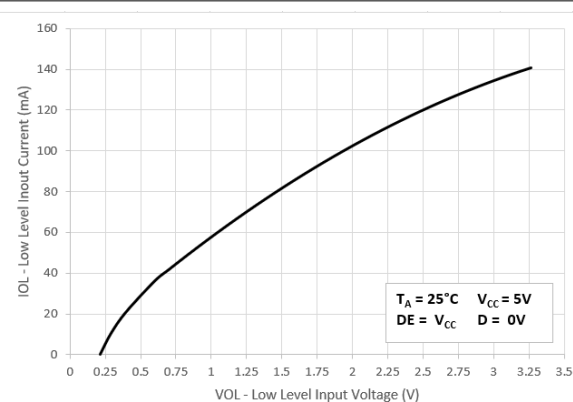


**Figure 5-6. BUS Input Current vs BUS Input Voltage**

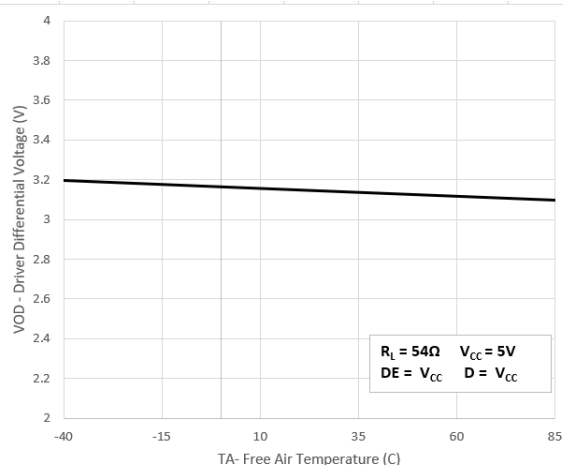
## 5.9 Typical Characteristics (continued)



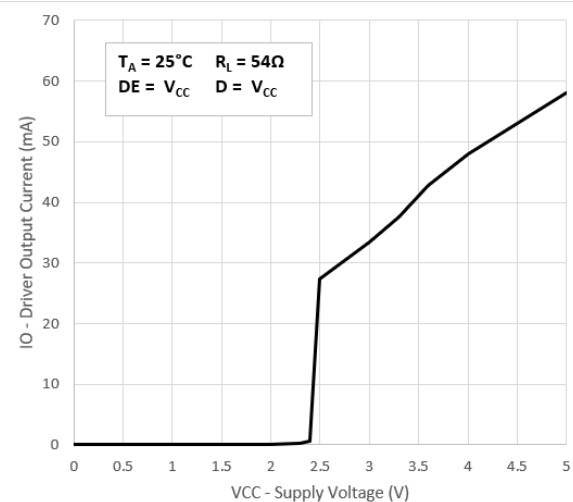
**Figure 5-7. Driver High-Level Output Current vs High-Level Output Voltage**



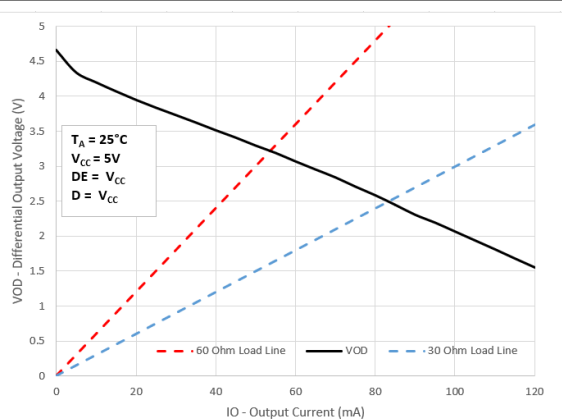
**Figure 5-8. Driver Low-Level Output Current vs Low-Level Output Voltage**



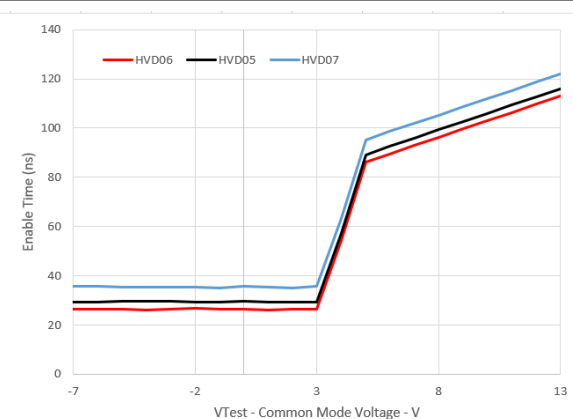
**Figure 5-9. Differential Output Voltage vs Free-Air Temperature**



**Figure 5-10. Driver Output Current vs Supply Voltage**



**Figure 5-11. Differential Output Voltage vs Differential Output Current**



**Figure 5-12. Enable Time vs Common-Mode Voltage  
(See Figure 5-13)**

## 5.9 Typical Characteristics (continued)

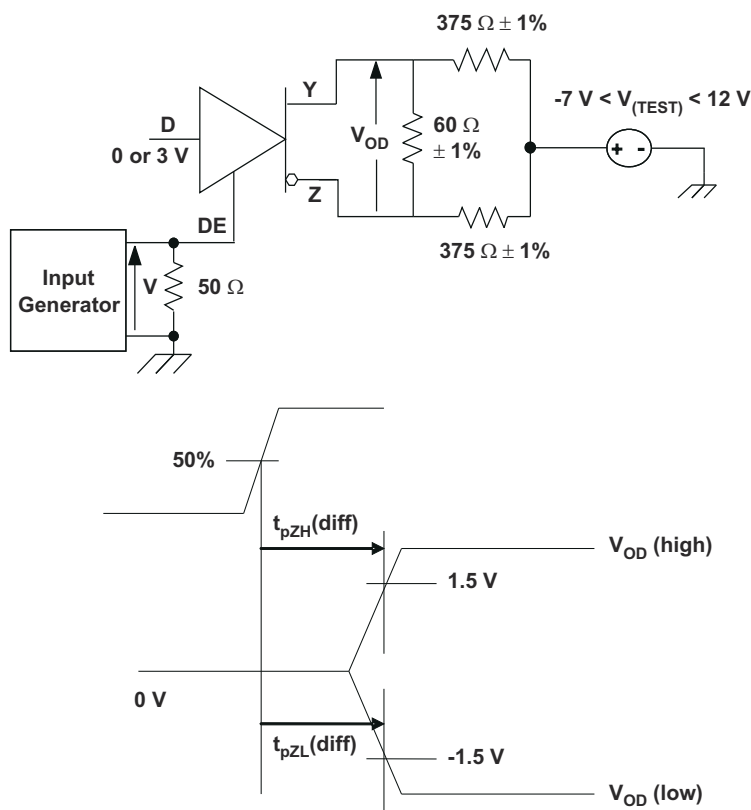


Figure 5-13. Driver Enable Time From DE to  $V_{OD}$

## Parameter Measurement Information

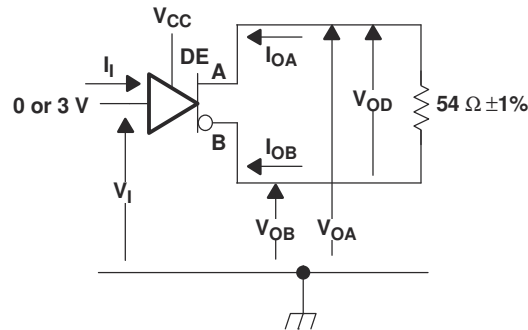


Figure 6-1. Driver  $V_{OD}$  Test Circuit and Voltage and Current Definitions

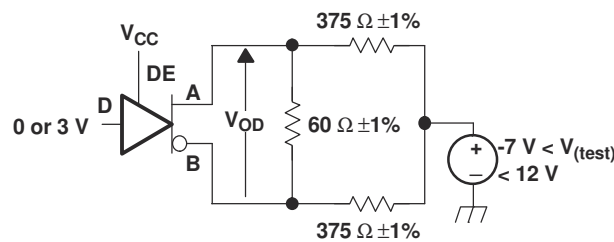


Figure 6-2. Driver  $V_{OD}$  With Common-Mode Loading Test Circuit

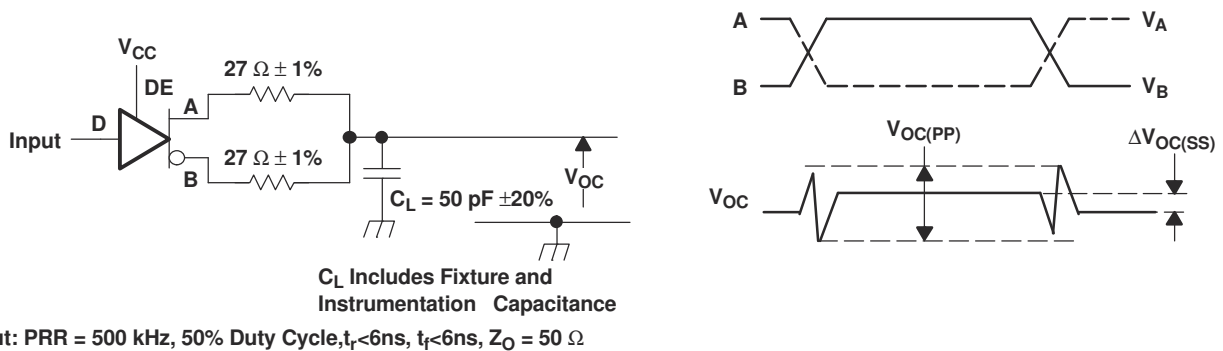


Figure 6-3. Test Circuit and Definitions for the Driver Common-Mode Output Voltage

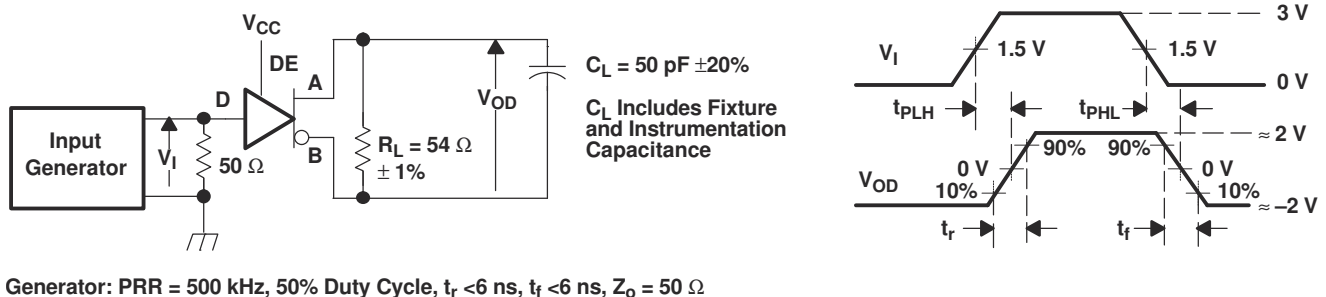
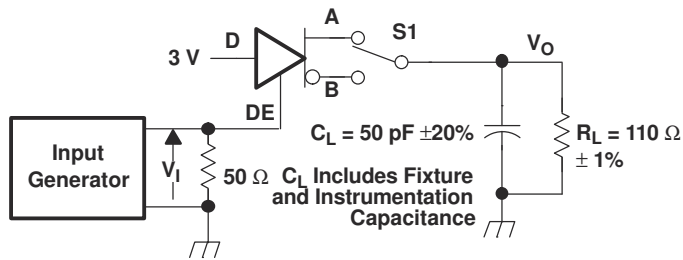
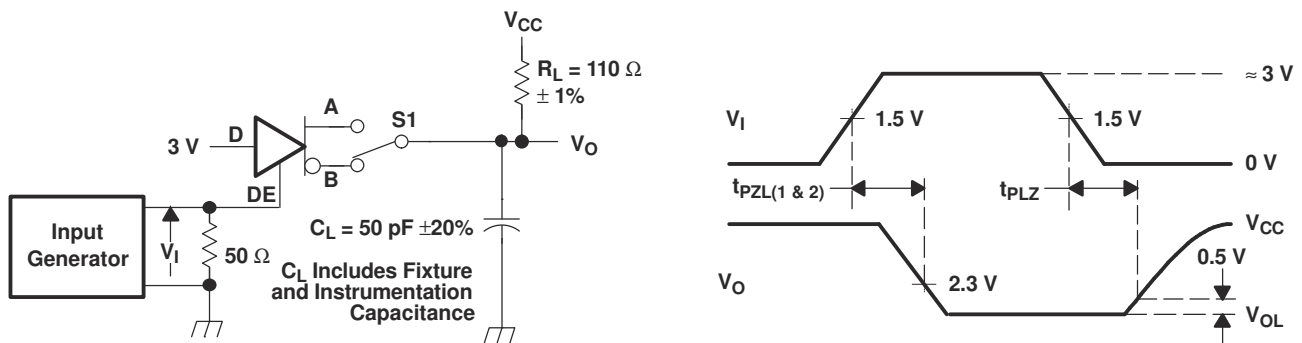


Figure 6-4. Driver Switching Test Circuit and Voltage Waveforms



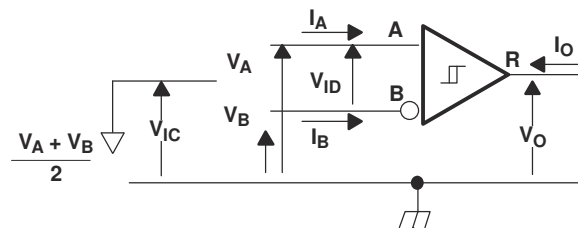
Generator: PRR = 100 kHz, 50% Duty Cycle,  $t_r < 6$  ns,  $t_f < 6$  ns,  $Z_o = 50 \Omega$

**Figure 6-5. Driver High-Level Enable and Disable Time Test Circuit and Voltage Waveforms**

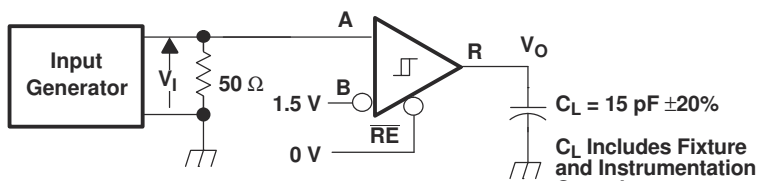


Generator: PRR = 100 kHz, 50% Duty Cycle,  $t_r < 6$  ns,  $t_f < 6$  ns,  $Z_o = 50 \Omega$

**Figure 6-6. Driver Low-Level Output Enable and Disable Time Test Circuit and Voltage Waveforms**



**Figure 6-7. Receiver Voltage and Current Definitions**



Generator: PRR = 100 kHz, 50% Duty Cycle,  $t_r < 6$  ns,  $t_f < 6$  ns,  $Z_o = 50 \Omega$

**Figure 6-8. Receiver Switching Test Circuit and Voltage Waveforms**

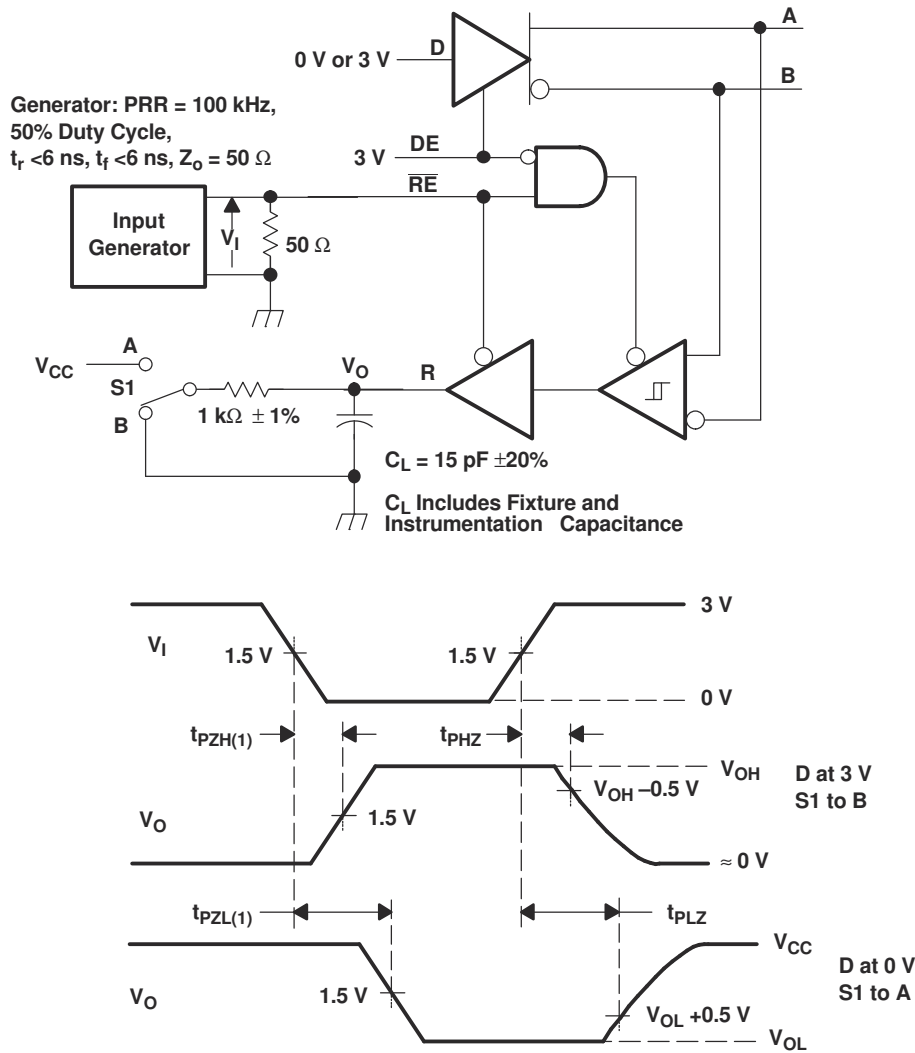


Figure 6-9. Receiver Enable and Disable Time Test Circuit and Voltage Waveforms With Drivers Enabled

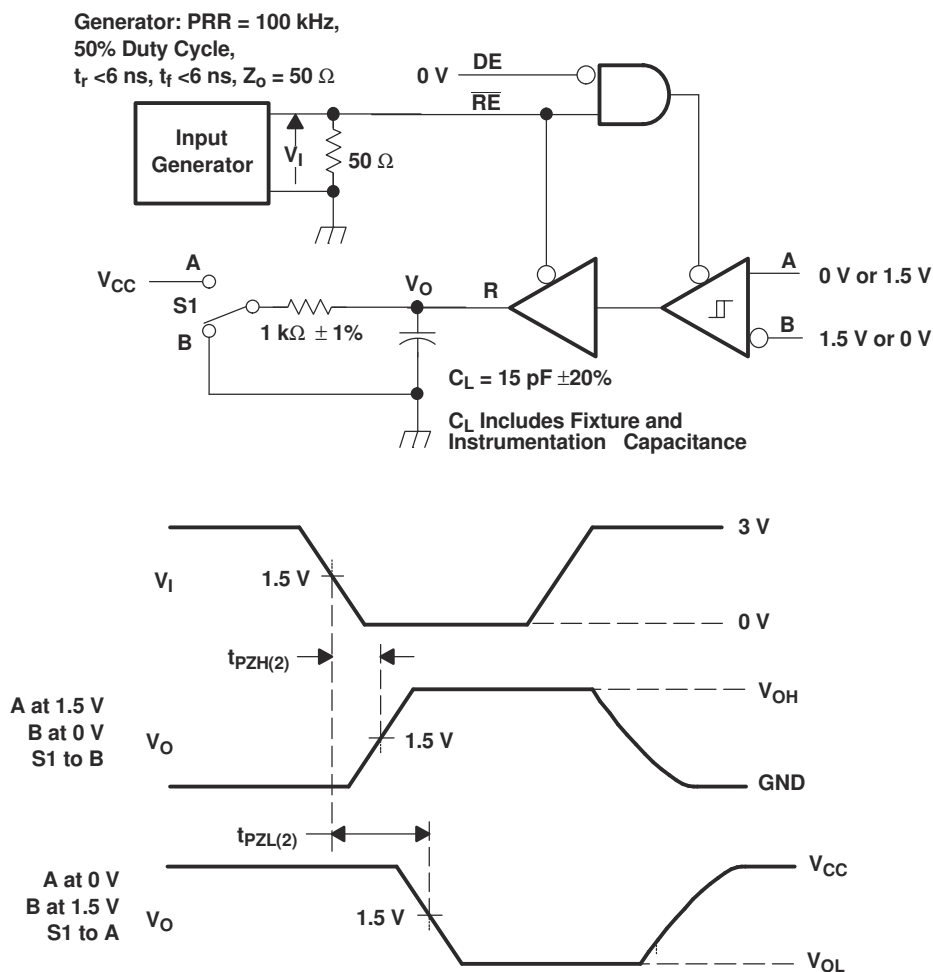
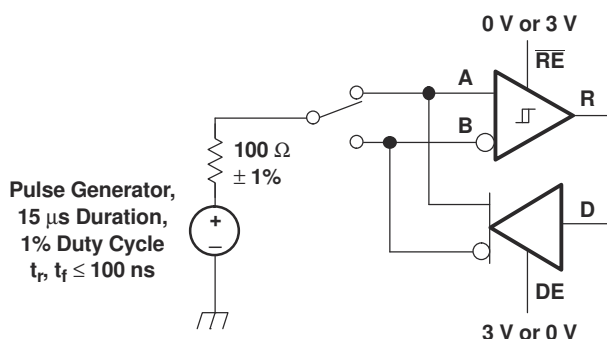


Figure 6-10. Receiver Enable Time From Standby (Driver Disabled)



NOTE: This test is conducted to test survivability only. Data stability at the R output is not specified.

Figure 6-11. Test Circuit, Transient Over Voltage Test

## 6 Function Tables

**Table 6-1. DRIVER**

| INPUT | ENABLE | OUTPUTS |   |
|-------|--------|---------|---|
| D     | DE     | A       | B |
| H     | H      | H       | L |
| L     | H      | L       | H |
| X     | L      | Z       | Z |
| Open  | H      | H       | L |
| X     | Open   | Z       | Z |

**Table 6-2. RECEIVER**

| DIFFERENTIAL INPUTS <sup>(1)</sup>          | ENABLE          | OUTPUT |
|---------------------------------------------|-----------------|--------|
| $V_{ID} = V_A - V_B$                        | $\overline{RE}$ | R      |
| $V_{ID} \leq -0.2 \text{ V}$                | L               | L      |
| $-0.2 \text{ V} < V_{ID} < -0.01 \text{ V}$ | L               | ?      |
| $-0.01 \text{ V} \leq V_{ID}$               | L               | H      |
| X                                           | H               | Z      |
| Open Circuit                                | L               | H      |
| Short Circuit                               | L               | H      |
| IDLE Bus                                    | L               | H      |
| X                                           | Open            | Z      |

(1) H = high level; L = low level; Z = high impedance; X = irrelevant;  
 ? = indeterminate

### 6.1 Receiver Failsafe

The differential receiver is “failsafe” to invalid bus states caused by:

- open bus conditions such as a disconnected connector,
- shorted bus conditions such as cable damage shorting the twisted-pair together, or
- idle bus conditions that occur when no driver on the bus is actively driving

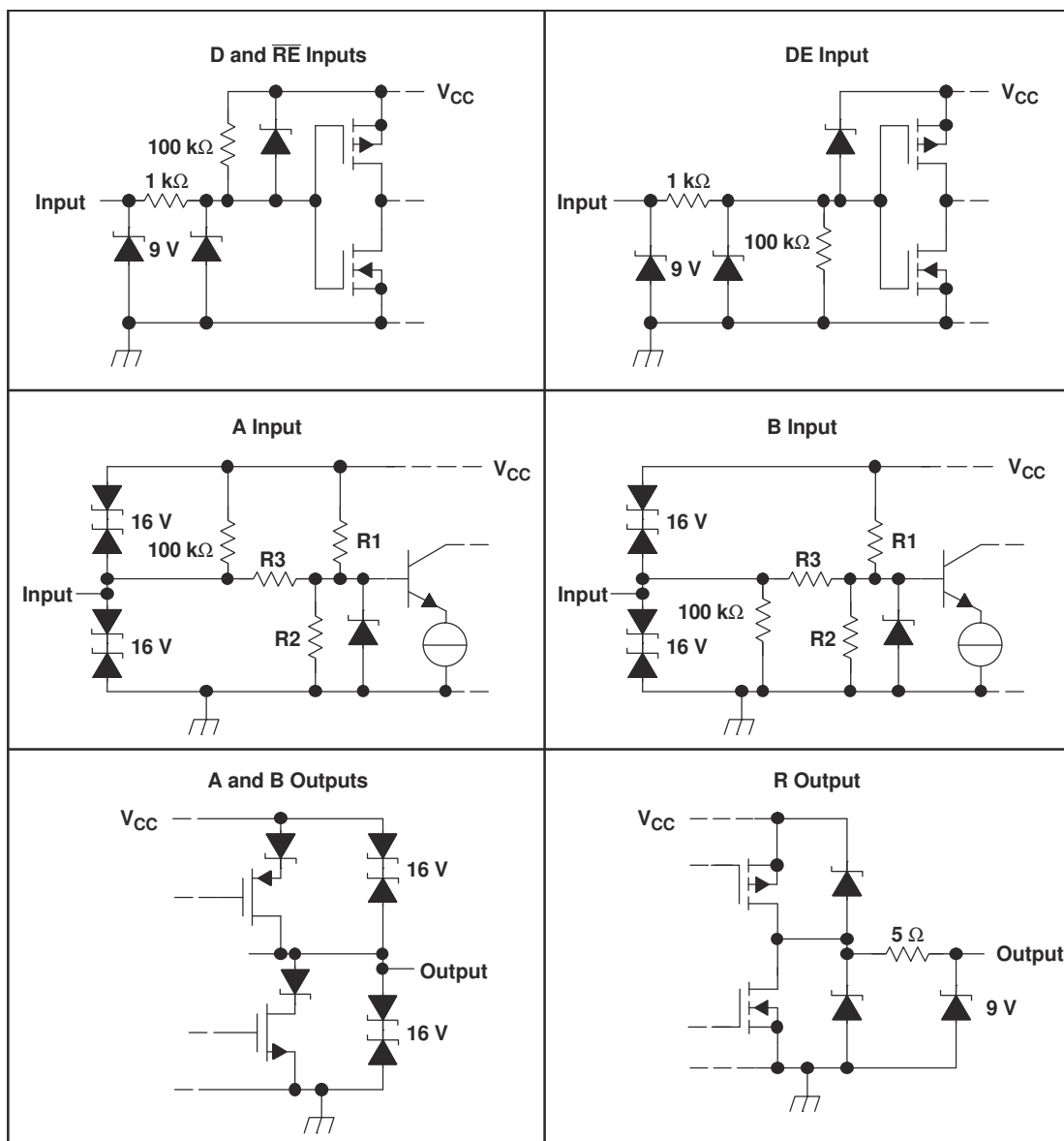
In any of these cases, the differential receiver outputs a failsafe logic High state, so that the output of the receiver is not indeterminate.

Receiver failsafe is accomplished by offsetting the receiver thresholds so that the “input indeterminate” range does not include zero volts differential. To comply with the RS-422 and RS-485 standards, the receiver output *must* output a High when the differential input  $V_{ID}$  is more positive than +200 mV, and *must* output a Low when the  $V_{ID}$  is more negative than -200 mV. The receiver parameters which determine the failsafe performance are  $V_{IT+}$  and  $V_{IT-}$  and  $V_{HYS}$ . As seen in the [Receiver Electrical Characteristics](#) table, differential signals more negative than -200 mV will always cause a Low receiver output. Similarly, differential signals more positive than +200 mV will *always* cause a High receiver output.

When the differential input signal is close to zero, it will still be above the  $V_{IT+}$  threshold, and the receiver output is High. Only when the differential input is more negative than  $V_{IT-}$  will the receiver output transition to a Low state. So, the noise immunity of the receiver inputs during a bus fault condition includes the receiver hysteresis value  $V_{HYS}$  (the separation between  $V_{IT+}$  and  $V_{IT-}$ ) as well as the value of  $V_{IT+}$ .



## 7 Equivalent Input and Output Schematic Diagrams



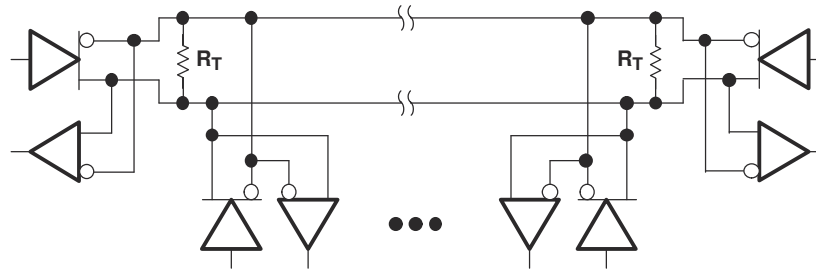
|           | R1/R2 | R3     |
|-----------|-------|--------|
| SN65HVD05 | 9 kΩ  | 45 kΩ  |
| SN65HVD06 | 36 kΩ | 180 kΩ |
| SN65HVD07 | 36 kΩ | 180 kΩ |

## 8 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### Typical Application



| Device | Number of Devices on Bus |
|--------|--------------------------|
| HVD05  | 64                       |
| HVD06  | 256                      |
| HVD07  | 256                      |

NOTE: The line should be terminated at both ends with its characteristic impedance ( $R_T = Z_O$ ).  
 Stub lengths off the main line should be kept as short as possible.

**Figure 8-1. Typical Application Circuit**

## 9 Device and Documentation Support

### 9.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 9.2 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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### 9.3 Trademarks

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All trademarks are the property of their respective owners.

### 9.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 9.5 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number       | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SN65HVD05D</a>  | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | VP05                |
| <a href="#">SN65HVD05DR</a> | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | VP05                |
| SN65HVD05DR.A               | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | VP05                |
| SN65HVD05DRG4               | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | VP05                |
| SN65HVD05DRG4.A             | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | VP05                |
| <a href="#">SN65HVD05P</a>  | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | 65HVD05             |
| SN65HVD05P.A                | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | 65HVD05             |
| <a href="#">SN65HVD06DR</a> | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | VP06                |
| SN65HVD06DR.A               | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | VP06                |
| <a href="#">SN65HVD06P</a>  | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | 65HVD06             |
| SN65HVD06P.A                | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | 65HVD06             |
| <a href="#">SN65HVD07D</a>  | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | VP07                |
| <a href="#">SN65HVD07DR</a> | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | VP07                |
| SN65HVD07DR.A               | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | VP07                |
| SN65HVD07DRG4               | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | VP07                |
| SN65HVD07DRG4.A             | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | VP07                |
| <a href="#">SN65HVD07P</a>  | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | 65HVD07             |
| SN65HVD07P.A                | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | 65HVD07             |
| <a href="#">SN75HVD05D</a>  | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | VN05                |
| <a href="#">SN75HVD05P</a>  | Obsolete      | Production           | PDIP (P)   8   | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | 75HVD05             |
| <a href="#">SN75HVD06D</a>  | Active        | Production           | SOIC (D)   8   | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | VN06                |
| SN75HVD06D.A                | Active        | Production           | SOIC (D)   8   | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | VN06                |
| <a href="#">SN75HVD06DR</a> | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | VN06                |
| SN75HVD06DR.A               | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | VN06                |
| <a href="#">SN75HVD07D</a>  | Active        | Production           | SOIC (D)   8   | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | VN07                |
| SN75HVD07D.A                | Active        | Production           | SOIC (D)   8   | 75   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | VN07                |
| <a href="#">SN75HVD07DR</a> | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | VN07                |
| SN75HVD07DR.A               | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | VN07                |
| <a href="#">SN75HVD07P</a>  | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | 75HVD07             |

| Orderable part number | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| SN75HVD07P.A          | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | 75HVD07             |

- <sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).
- <sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.
- <sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.
- <sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- <sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- <sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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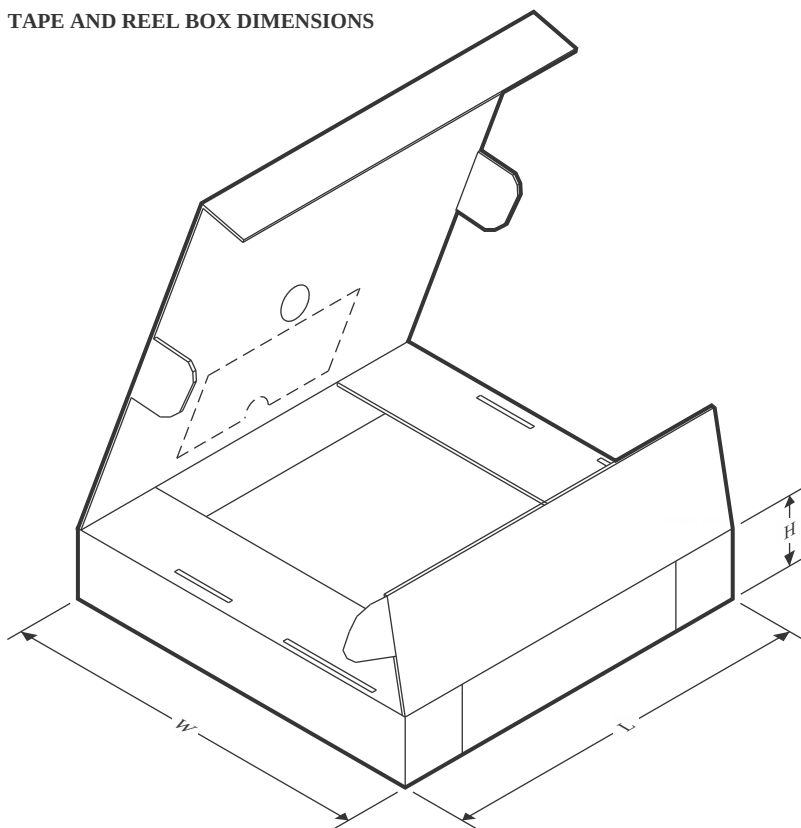
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN65HVD05DR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| SN65HVD05DRG4 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| SN65HVD06DR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| SN65HVD07DR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| SN65HVD07DRG4 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| SN75HVD06DR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| SN75HVD07DR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |

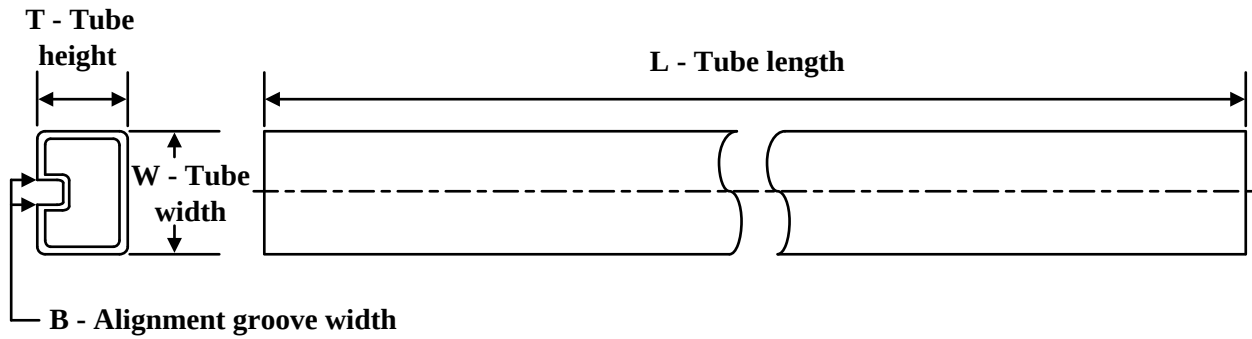
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN65HVD05DR   | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| SN65HVD05DRG4 | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| SN65HVD06DR   | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| SN65HVD07DR   | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| SN65HVD07DRG4 | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| SN75HVD06DR   | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| SN75HVD07DR   | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |

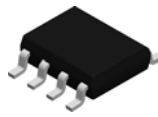
## TUBE



\*All dimensions are nominal

| Device       | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN65HVD05P   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| SN65HVD05P.A | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| SN65HVD06P   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| SN65HVD06P.A | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| SN65HVD07P   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| SN65HVD07P.A | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| SN75HVD06D   | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| SN75HVD06D.A | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| SN75HVD07D   | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| SN75HVD07D.A | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| SN75HVD07P   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| SN75HVD07P.A | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |



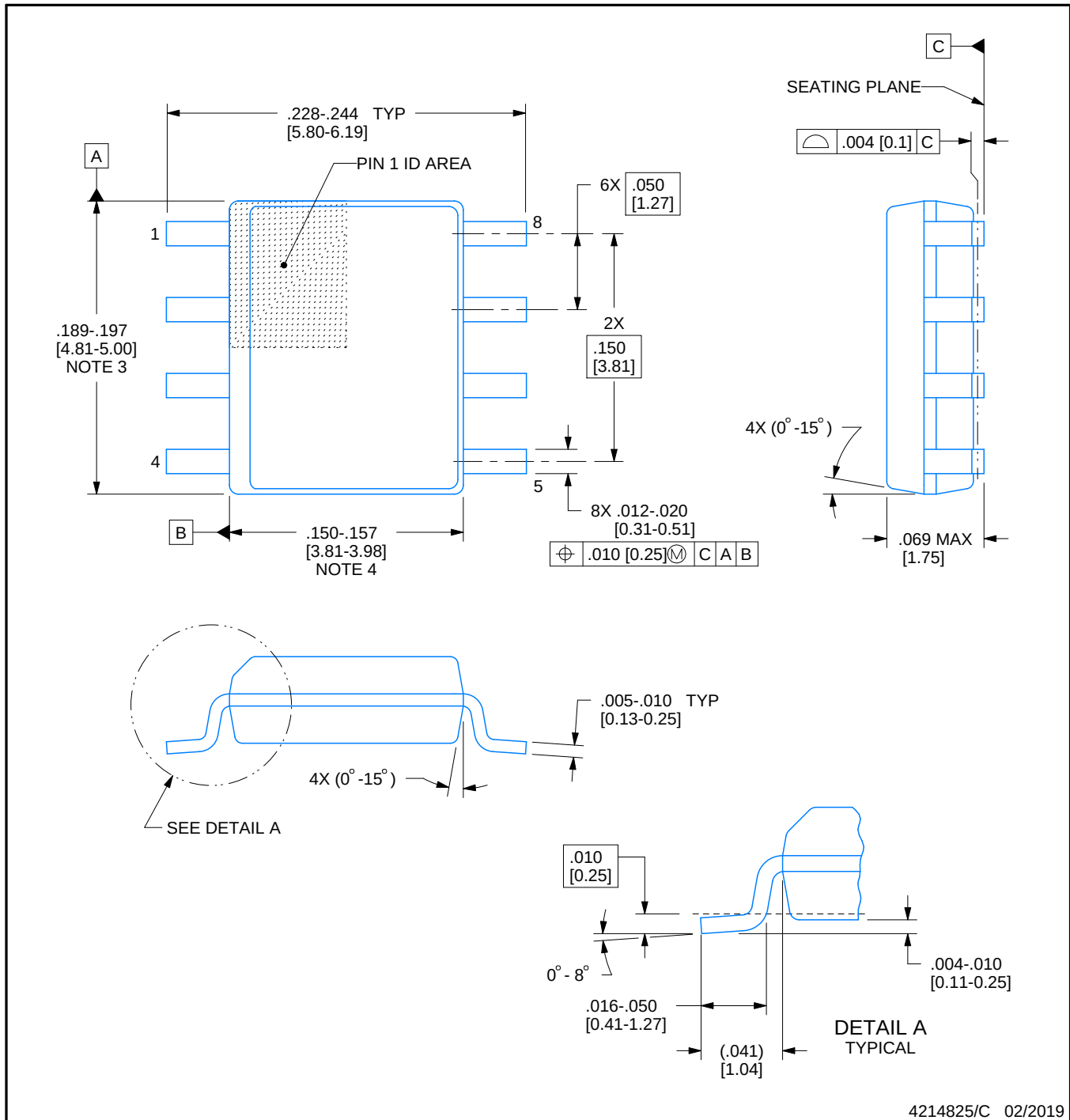


**D0008A**

# PACKAGE OUTLINE

**SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

## NOTES:

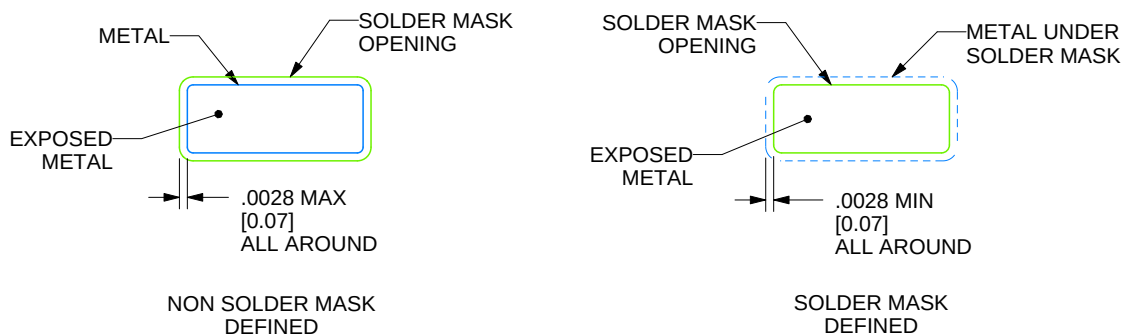
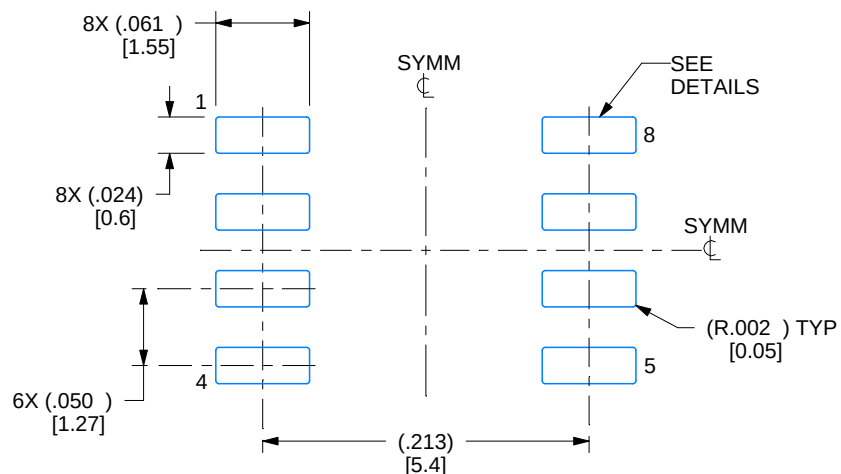
1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

# EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

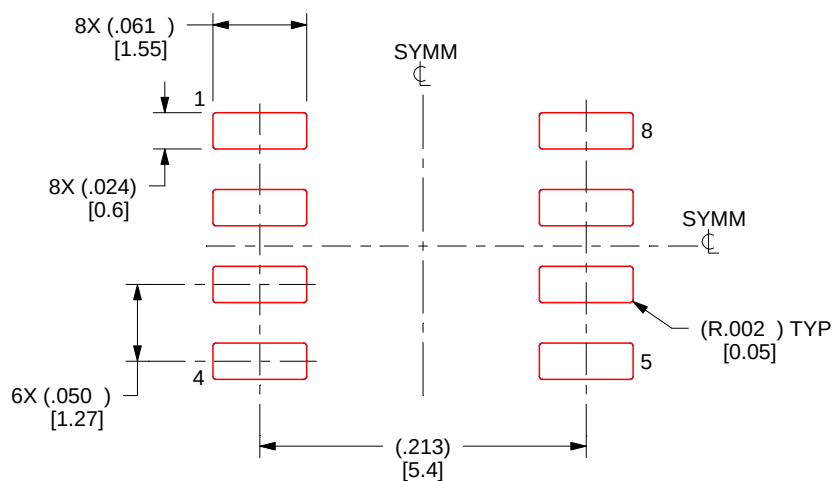
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

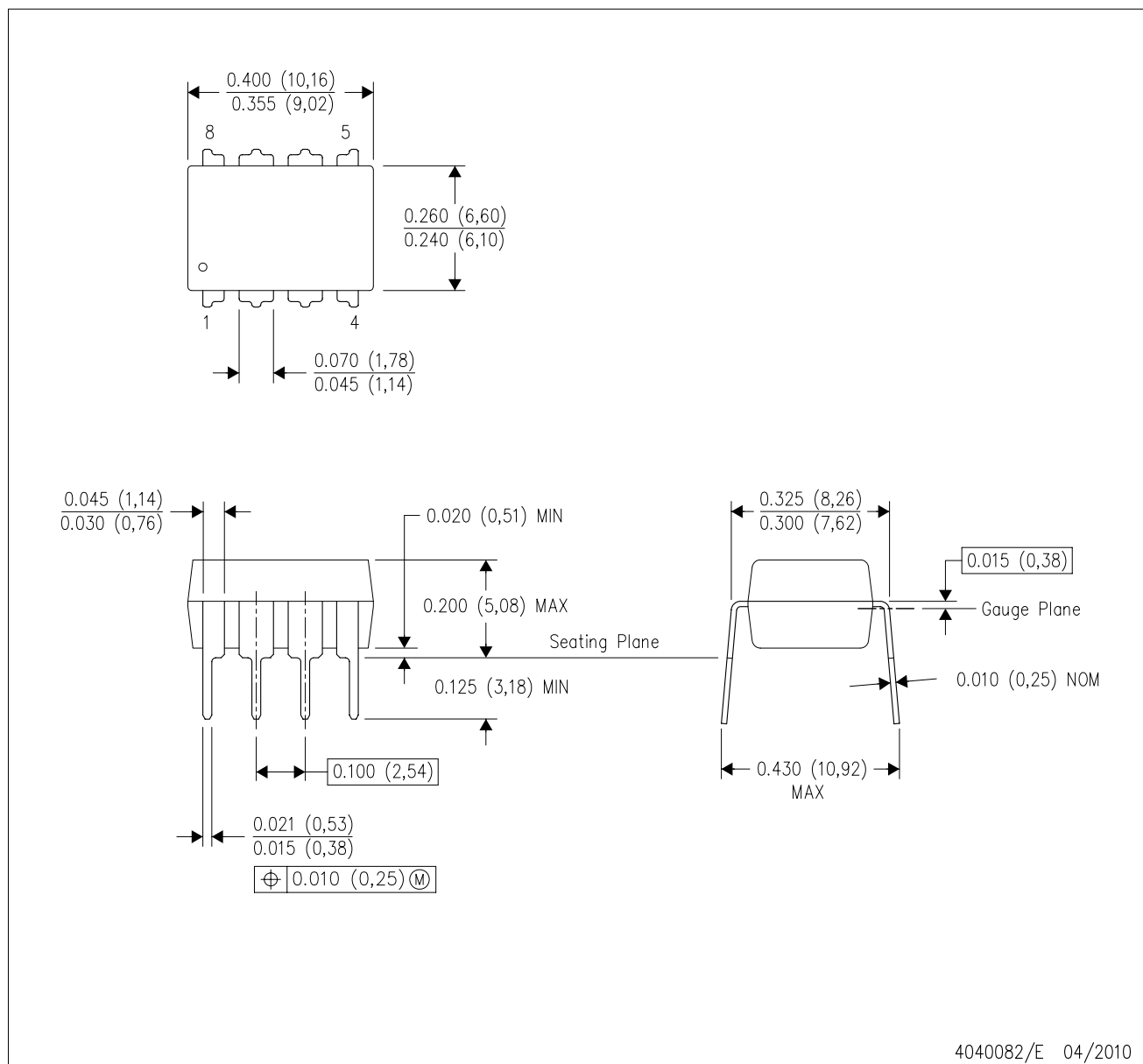
4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.

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